

## J417-TL-VB Datasheet

### P-Channel 30-V (D-S) MOSFET

#### PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ )   | $I_D$ (A) <sup>d</sup> | $Q_g$ (Typ.) |
|--------------|-----------------------------|------------------------|--------------|
| - 30         | 0.033 at $V_{GS} = - 10$ V  | - 38                   | 19 nC        |
|              | 0.046 at $V_{GS} = - 4.5$ V | - 25                   |              |

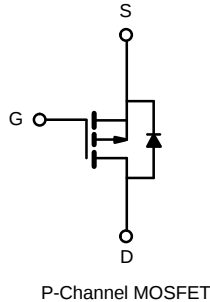
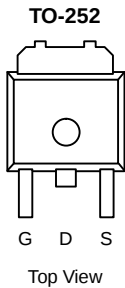
#### FEATURES

- Halogen-free
- Trench Power MOSFET
- 100 %  $R_g$  Tested
- 100 % UIS Tested


**RoHS**  
 COMPLIANT

#### APPLICATIONS

- Load Switch
- Notebook Adaptor Switch



#### ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

| Parameter                                        |               | Symbol         | Limit                  | Unit |
|--------------------------------------------------|---------------|----------------|------------------------|------|
| Drain-Source Voltage                             |               | $V_{DS}$       | - 30                   | V    |
| Gate-Source Voltage                              |               | $V_{GS}$       | $\pm 20$               |      |
| Continuous Drain Current ( $T_J = 150$ °C)       | $T_C = 25$ °C | $I_D$          | - 38                   | A    |
|                                                  | $T_C = 70$ °C |                | - 25                   |      |
|                                                  | $T_A = 25$ °C |                | - 14.9 <sup>a, b</sup> |      |
|                                                  | $T_A = 70$ °C |                | - 13.6 <sup>a, b</sup> |      |
| Pulsed Drain Current                             |               | $I_{DM}$       | - 112                  |      |
| Continuous Source-Drain Diode Current            | $T_C = 25$ °C | $I_S$          | - 4.1                  |      |
|                                                  | $T_A = 25$ °C |                | - 2.2 <sup>a, b</sup>  |      |
| Avalanche Current                                |               | $I_{AS}$       | - 20                   | mJ   |
| Single-Pulse Avalanche Energy                    |               | $E_{AS}$       | 20                     |      |
| Maximum Power Dissipation                        | $T_C = 25$ °C | $P_D$          | 25                     | W    |
|                                                  | $T_C = 70$ °C |                | 20                     |      |
|                                                  | $T_A = 25$ °C |                | 2.7 <sup>a, b</sup>    |      |
|                                                  | $T_A = 70$ °C |                | 1.7 <sup>a, b</sup>    |      |
| Operating Junction and Storage Temperature Range |               | $T_J, T_{stg}$ | - 55 to 150            | °C   |

#### THERMAL RESISTANCE RATINGS

| Parameter                                   |               | Symbol     | Typical | Maximum | Unit |
|---------------------------------------------|---------------|------------|---------|---------|------|
| Maximum Junction-to-Ambient <sup>a, c</sup> | $t \leq 10$ s | $R_{thJA}$ | 38      | 46      | °C/W |
| Maximum Junction-to-Foot                    | Steady State  | $R_{thJF}$ | 20      | 25      |      |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

 b.  $t = 10$  s.

c. Maximum under Steady State conditions is 85 °C/W.

 d. Based on  $T_C = 25$  °C.

| SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted |                         |                                                                                                                              |       |        |           |                           |  |
|----------------------------------------------------------------------------|-------------------------|------------------------------------------------------------------------------------------------------------------------------|-------|--------|-----------|---------------------------|--|
| Parameter                                                                  | Symbol                  | Test Conditions                                                                                                              | Min.  | Typ.   | Max.      | Unit                      |  |
| Static                                                                     |                         |                                                                                                                              |       |        |           |                           |  |
| Drain-Source Breakdown Voltage                                             | $V_{DS}$                | $V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$                                                                         | - 30  |        |           | V                         |  |
| $V_{DS}$ Temperature Coefficient                                           | $\Delta V_{DS}/T_J$     | $I_D = -250\text{ }\mu\text{A}$                                                                                              |       | - 34   |           | mV/<br>$^{\circ}\text{C}$ |  |
| $V_{GS(th)}$ Temperature Coefficient                                       | $\Delta V_{GS(th)}/T_J$ |                                                                                                                              |       | 5.3    |           |                           |  |
| Gate-Source Threshold Voltage                                              | $V_{GS(th)}$            | $V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$                                                                             | - 1.0 |        | - 2.5     | V                         |  |
| Gate-Source Leakage                                                        | $I_{GSS}$               | $V_{DS} = 0\text{ V}, V_{GS} = \pm 25\text{ V}$                                                                              |       |        | $\pm 100$ | nA                        |  |
| Zero Gate Voltage Drain Current                                            | $I_{DSS}$               | $V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$                                                                                 |       |        | - 1       | $\mu\text{A}$             |  |
|                                                                            |                         | $V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^{\circ}\text{C}$                                               |       |        | - 5       |                           |  |
| On-State Drain Current <sup>a</sup>                                        | $I_{D(on)}$             | $V_{DS} \geq -10\text{ V}, V_{GS} = -10\text{ V}$                                                                            | - 30  |        |           | A                         |  |
| Drain-Source On-State Resistance <sup>a</sup>                              | $R_{DS(on)}$            | $V_{GS} = -10\text{ V}, I_D = -10\text{ A}$                                                                                  |       | 0.033  |           | $\Omega$                  |  |
|                                                                            |                         | $V_{GS} = -4.5\text{ V}, I_D = -8\text{ A}$                                                                                  |       | 0.046  |           |                           |  |
| Forward Transconductance <sup>a</sup>                                      | $g_{fs}$                | $V_{DS} = -10\text{ V}, I_D = -10\text{ A}$                                                                                  |       | 28     |           | S                         |  |
| Dynamic <sup>b</sup>                                                       |                         |                                                                                                                              |       |        |           |                           |  |
| Input Capacitance                                                          | $C_{iss}$               | $V_{DS} = -15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$                                                               |       | 1350   |           | pF                        |  |
| Output Capacitance                                                         | $C_{oss}$               |                                                                                                                              |       | 255    |           |                           |  |
| Reverse Transfer Capacitance                                               | $C_{rss}$               |                                                                                                                              |       | 190    |           |                           |  |
| Total Gate Charge                                                          | $Q_g$                   | $V_{DS} = -15\text{ V}, V_{GS} = -10\text{ V}, I_D = -10\text{ A}$                                                           |       | 27     | 43        | nC                        |  |
|                                                                            |                         | $V_{DS} = -15\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -10\text{ A}$                                                          |       | 19     | 25        |                           |  |
|                                                                            |                         |                                                                                                                              |       |        | 6         |                           |  |
|                                                                            |                         |                                                                                                                              |       |        | 12        |                           |  |
| Gate-Source Charge                                                         | $Q_{gs}$                |                                                                                                                              |       |        |           |                           |  |
| Gate-Drain Charge                                                          | $Q_{gd}$                |                                                                                                                              |       |        |           |                           |  |
| Gate Resistance                                                            | $R_g$                   | $f = 1\text{ MHz}$                                                                                                           | 0.5   | 2.2    | 4.4       | $\Omega$                  |  |
| Turn-On Delay Time                                                         | $t_{d(on)}$             | $V_{DD} = -15\text{ V}, R_L = 1.5\text{ }\Omega$<br>$I_D \cong -10\text{ A}, V_{GEN} = -10\text{ V}, R_g = 1\text{ }\Omega$  |       | 13     | 25        | ns                        |  |
| Rise Time                                                                  | $t_r$                   |                                                                                                                              |       | 12     | 24        |                           |  |
| Turn-Off DelayTime                                                         | $t_{d(off)}$            |                                                                                                                              |       | 40     | 70        |                           |  |
| Fall Time                                                                  | $t_f$                   |                                                                                                                              |       | 9      | 18        |                           |  |
| Turn-On Delay Time                                                         | $t_{d(on)}$             | $V_{DD} = -15\text{ V}, R_L = 1.5\text{ }\Omega$<br>$I_D \cong -10\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 1\text{ }\Omega$ |       | 48     | 80        |                           |  |
| Rise Time                                                                  | $t_r$                   |                                                                                                                              |       | 92     | 160       |                           |  |
| Turn-Off DelayTime                                                         | $t_{d(off)}$            |                                                                                                                              |       | 34     | 60        |                           |  |
| Fall Time                                                                  | $t_f$                   |                                                                                                                              |       | 19     | 35        |                           |  |
| Drain-Source Body Diode Characteristics                                    |                         |                                                                                                                              |       |        |           |                           |  |
| Continous Source-Drain Diode Current                                       | $I_S$                   | $T_C = 25\text{ }^{\circ}\text{C}$                                                                                           |       |        | - 4.1     | A                         |  |
| Pulse Diode Forward Current                                                | $I_{SM}$                |                                                                                                                              |       |        | - 40      |                           |  |
| Body Diode Voltage                                                         | $V_{SD}$                | $I_S = -3\text{ A}, V_{GS} = 0\text{ V}$                                                                                     |       | - 0.75 | - 1.2     | V                         |  |
| Body Diode Reverse Recovery Time                                           | $t_{rr}$                | $I_F = -10\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^{\circ}\text{C}$                                     |       | 27     | 45        | ns                        |  |
| Body Diode Reverse Recovery Charge                                         | $Q_{rr}$                |                                                                                                                              |       | 16     | 27        | nC                        |  |
| Reverse Recovery Fall Time                                                 | $t_a$                   |                                                                                                                              |       | 12     |           | ns                        |  |
| Reverse Recovery Rise Time                                                 | $t_b$                   |                                                                                                                              |       | 15     |           |                           |  |

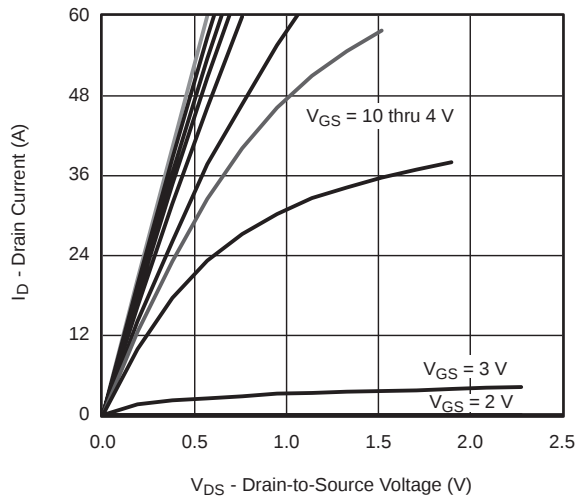
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

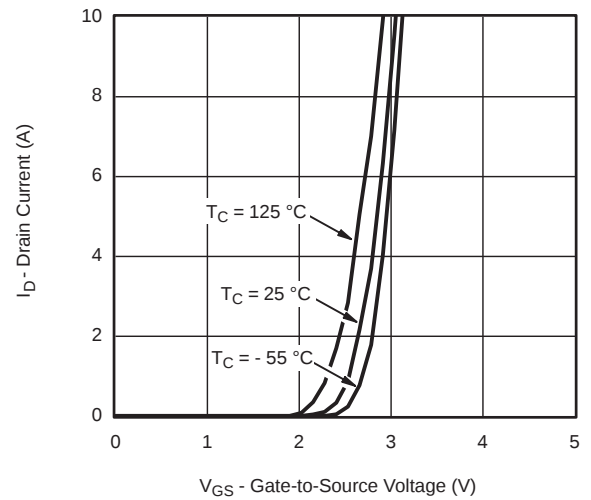
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

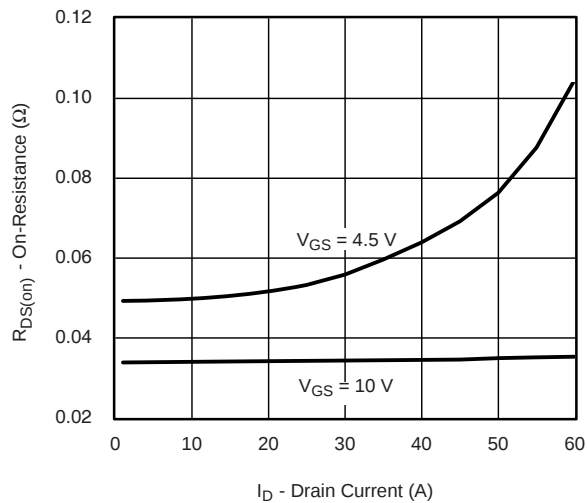
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



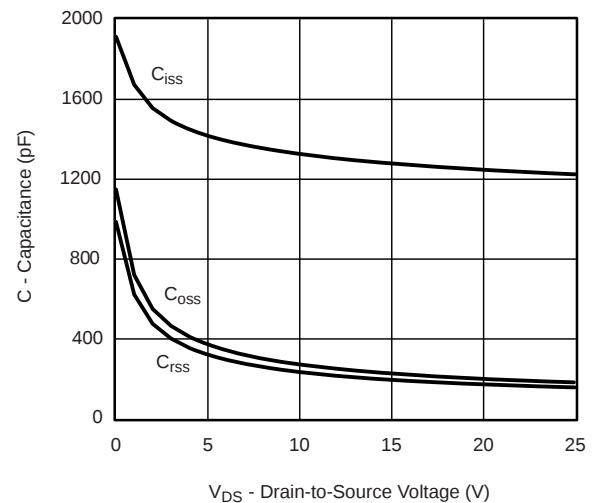
Output Characteristics



Transfer Characteristics



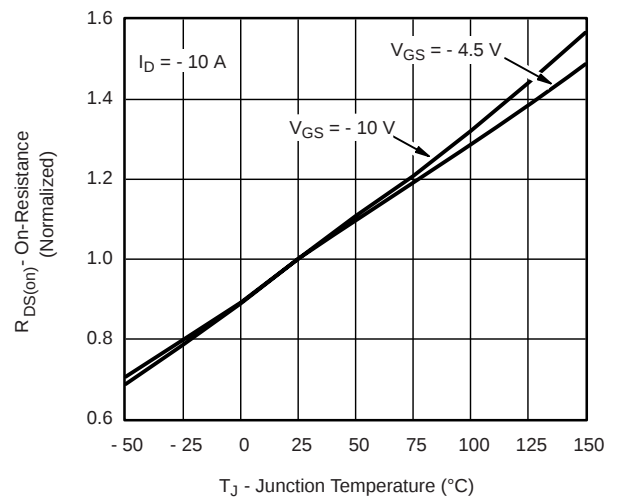
On-Resistance vs. Drain Current



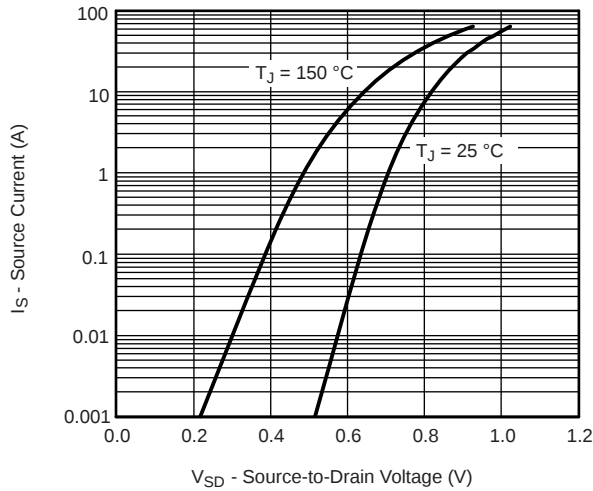
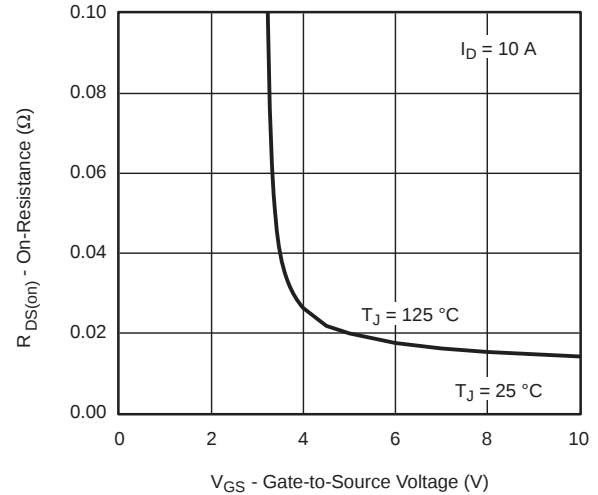
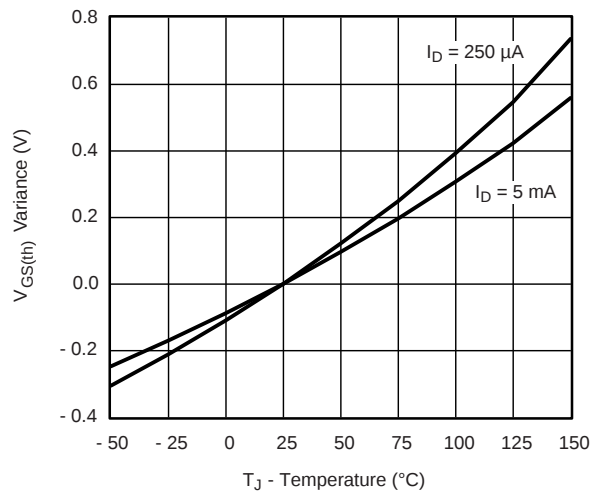
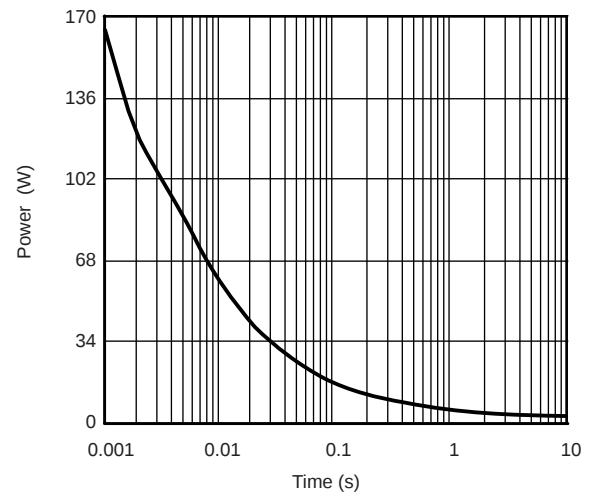
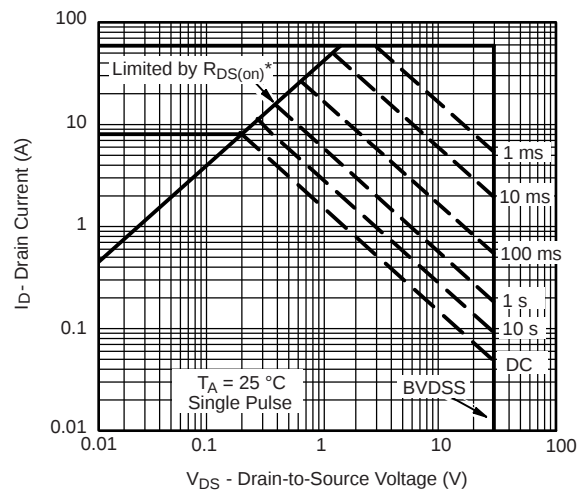
Capacitance



Gate Charge

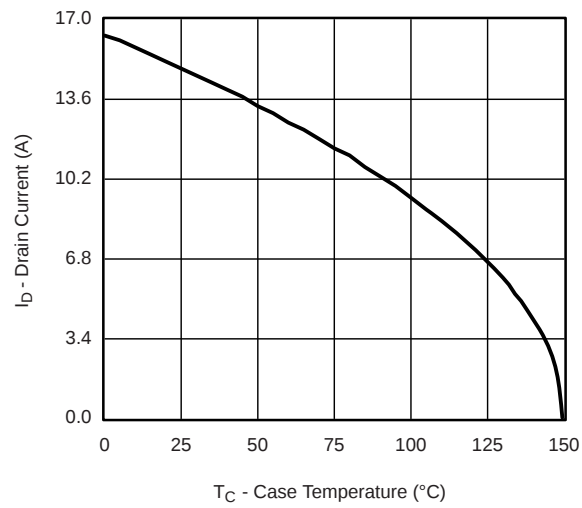
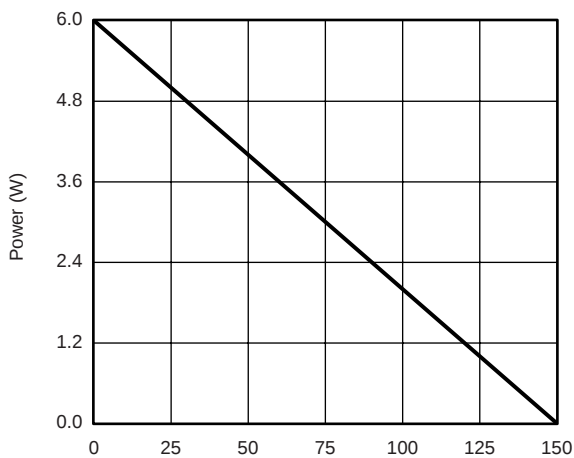
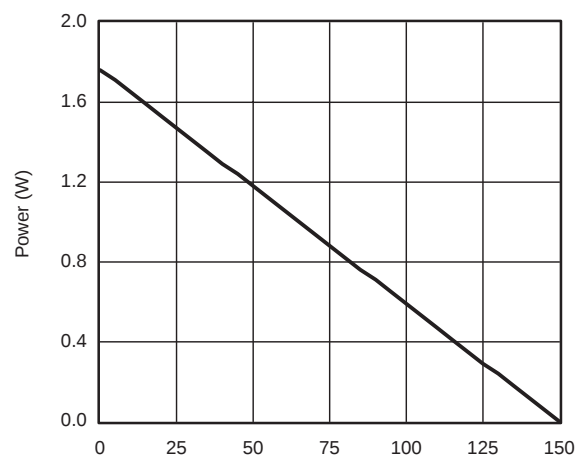


On-Resistance vs. Junction Temperature

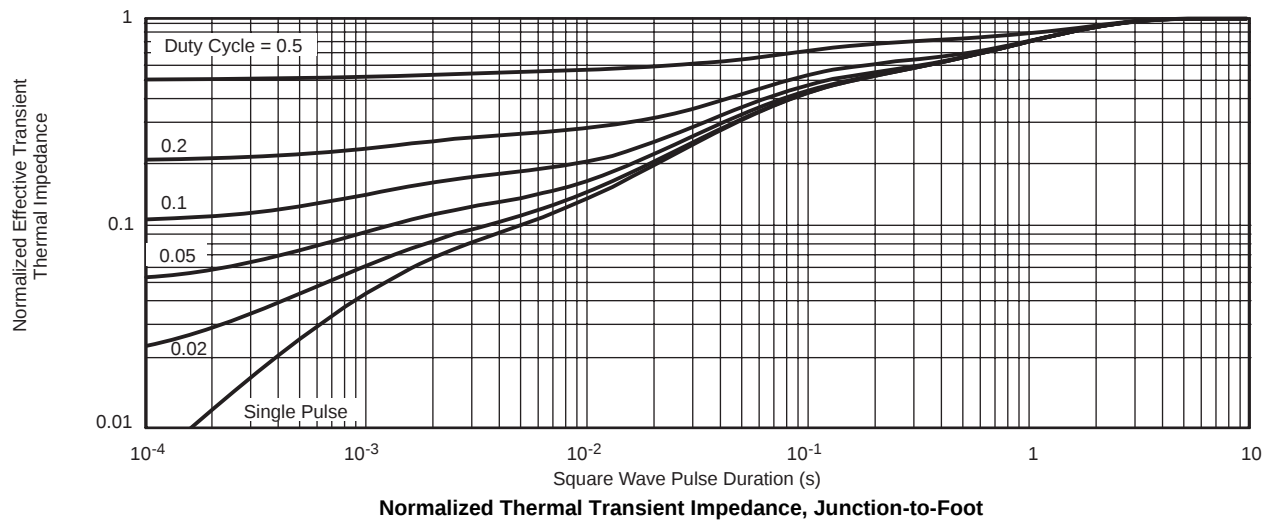
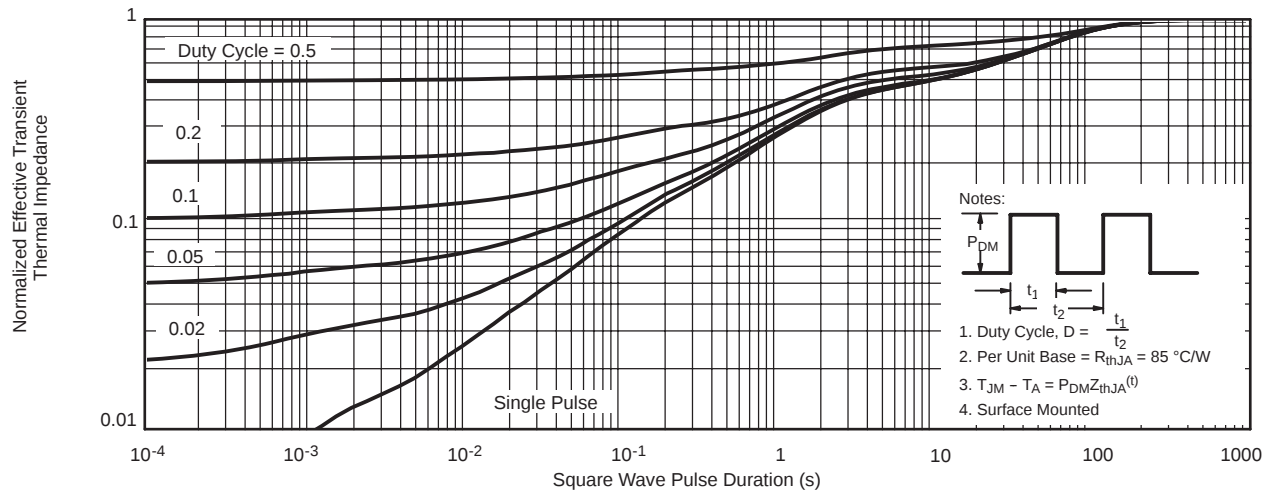
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Source-Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Single Pulse Power, Junction-to-Ambient**


\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

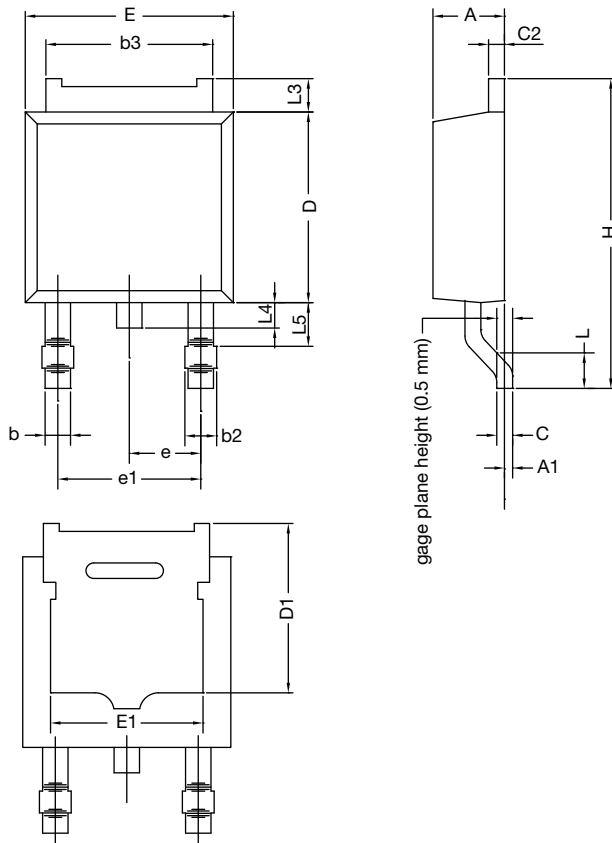
**Safe Operating Area**

**MOSFET TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Current Derating\***

**Power, Junction-to-Foot**

**Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


## TO-252AA CASE OUTLINE

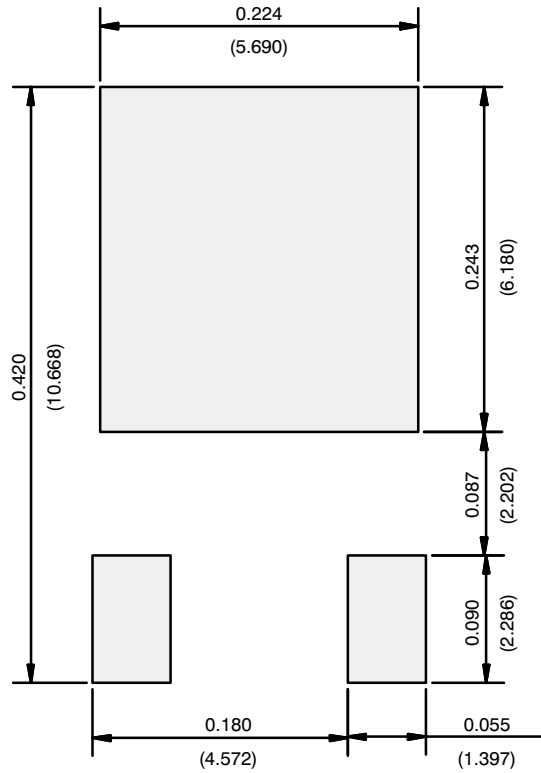


| DIM.                            | MILLIMETERS |       | INCHES    |       |
|---------------------------------|-------------|-------|-----------|-------|
|                                 | MIN.        | MAX.  | MIN.      | MAX.  |
| A                               | 2.18        | 2.38  | 0.086     | 0.094 |
| A1                              | -           | 0.127 | -         | 0.005 |
| b                               | 0.64        | 0.88  | 0.025     | 0.035 |
| b2                              | 0.76        | 1.14  | 0.030     | 0.045 |
| b3                              | 4.95        | 5.46  | 0.195     | 0.215 |
| C                               | 0.46        | 0.61  | 0.018     | 0.024 |
| C2                              | 0.46        | 0.89  | 0.018     | 0.035 |
| D                               | 5.97        | 6.22  | 0.235     | 0.245 |
| D1                              | 5.21        | -     | 0.205     | -     |
| E                               | 6.35        | 6.73  | 0.250     | 0.265 |
| E1                              | 4.32        | -     | 0.170     | -     |
| H                               | 9.40        | 10.41 | 0.370     | 0.410 |
| e                               | 2.28 BSC    |       | 0.090 BSC |       |
| e1                              | 4.56 BSC    |       | 0.180 BSC |       |
| L                               | 1.40        | 1.78  | 0.055     | 0.070 |
| L3                              | 0.89        | 1.27  | 0.035     | 0.050 |
| L4                              | -           | 1.02  | -         | 0.040 |
| L5                              | 1.14        | 1.52  | 0.045     | 0.060 |
| ECN: X12-0247-Rev. M, 24-Dec-12 |             |       |           |       |
| DWG: 5347                       |             |       |           |       |

### Note

- Dimension L3 is for reference only.

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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